V40M150C-M3, V40M150CHM3

Vishay General Semiconductor

Dual High-Voltage Trench MOS Barrier Schottky Rectifier

Ultra Low $V_F = 0.55 \text{ V}$ at $I_F = 5 \text{ A}$



| PRIMARY CHARACTERISTICS | | | | | |
|---|---------------------|--|--|--|--|
| I _{F(AV)} | 2 x 20 A | | | | |
| V_{RRM} | 150 V | | | | |
| I _{FSM} | 160 A | | | | |
| V _F at I _F = 20 A (T _A = 125 °C) | 0.75 V | | | | |
| T _J max. | 175 °C | | | | |
| Package | TO-220AB | | | | |
| Diode variations | Dual common cathode | | | | |

FEATURES

- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses

• High efficiency operation

Solder dip 275 °C max. 10 s, per JESD 22-B106

HALOGEN FREE

- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection.

MECHANICAL DATA

Case: TO-220AB

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and

commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix

meets JESD 201 class 2 whisker test

Polarity: As marked

Mounting Torque: 10 in-lbs maximum

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | | | |
|--|------------|-----------------------------------|-------------|------|--|
| PARAMETER | | SYMBOL | V40M150C | UNIT | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 150 | V | | |
| Maximum average forward rectified current (fig. 1) | per device | I _{F(AV)} | 40 | А | |
| | per diode | | 20 | | |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode | | I _{FSM} | 160 | ,, | |
| Operating junction and storage temperature range | | T _J , T _{STG} | -40 to +175 | °C | |

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| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | | | |
|---|------------------------|-------------------------|-------------------------------|------|------|------|--|--|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT | | |
| Instantaneous forward voltage per diode | I _F = 5 A | T _A = 25 °C | V _F (1) | 0.69 | - | . v | | |
| | I _F = 10 A | | | 0.84 | - | | | |
| | I _F = 20 A | | | 1.15 | 1.43 | | | |
| | I _F = 5 A | T _A = 125 °C | | 0.55 | - | | | |
| | I _F = 10 A | | | 0.64 | - | | | |
| | I _F = 20 A | | | 0.75 | 0.82 | | | |
| Reverse current per diode | V _R = 100 V | T _A = 25 °C | I _R ⁽²⁾ | 2 | - | μΑ | | |
| | | T _A = 125 °C | | 2.5 | 1 | mA | | |
| | | T _A = 25 °C | | - | 250 | μΑ | | |
| | | T _A = 125 °C | | 5 | 25 | mA | | |

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|---|------------|----------------------|----------|------|--|--|
| PARAMETER | | SYMBOL | V40M150C | UNIT | | |
| Typical thermal resistance (1) | per diode | $R_{	heta JC}$ | 1.8 | | | |
| | per device | | 1.2 | °C/W | | |
| | per device | R _{θJA} (2) | 52 | | | |

Notes

(1) The heat generated must be less than the thermal conductivity from junction-to-ambient $dP_D/dT_J < 1/R_{\theta,JA}$

(2) Free air, without heatsink

| ORDERING INFORMATION (Example) | | | | | | |
|--------------------------------|--------------------|-----------------|--------------|---------------|---------------|--|
| PACKAGE | PREFERRED P/N | UNIT WEIGHT (g) | PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | |
| TO-220AB | V40M150C-M3/4W | 1.89 | 4W | 50/tube | Tube | |
| TO-220AB | V40M150CHM3/4W (1) | 1.89 | 4W | 50/tube | Tube | |

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

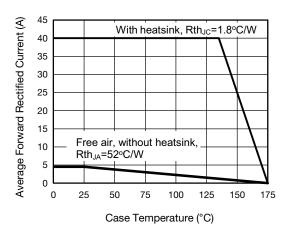


Fig. 1 - Maximum Forward Current Derating Curve (D = Duty Cycle = 0.5)

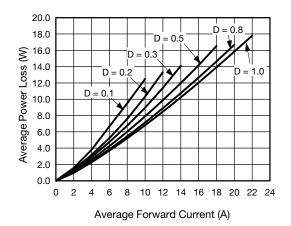


Fig. 2 - Forward Power Loss Characteristics Per Diode





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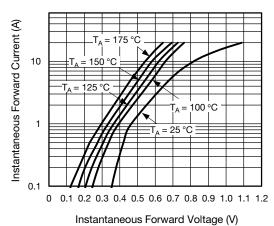


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

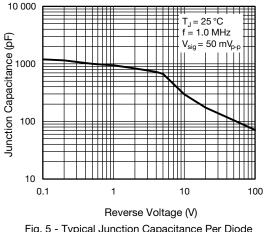


Fig. 5 - Typical Junction Capacitance Per Diode

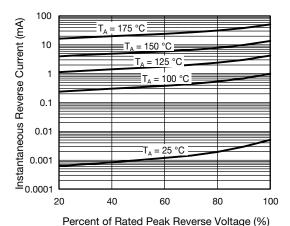


Fig. 4 - Typical Reverse Characteristics Per Diode

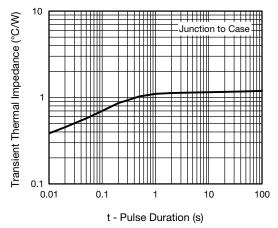
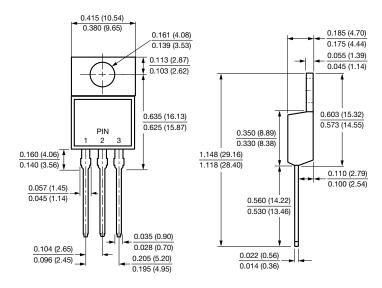


Fig. 6 - Typical Transient Thermal Impedance Per Diode

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

TO-220AB





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